



The new evolution in direct laser engraving for multiple applications



"All IN ONE" direct laser engraver replacing our successful HELIOS

Printers can produce the highest quality print with a shorter, solvent-free process, for longer runs and multiple cost saving potentials in the printing process.

NEW FEATURES

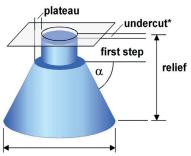
- No gas consumption sealed CO₂ laser generator
- **Lower operational cost** no process gas costs automatic "standby mode"
- Faster service analysis less downtime improved remote service control
- **Multiapplicational system** Dry offset / Intaglio / Varnish / Screen

ADDITIONAL FEATURES

- Solvent free process, sustainable single step dry process
- Stabel highlight dots less plate cleaning longer runs reduced process steps due to Active 3D® dot shaping (RIP) due to below surface dot
- "Open system" license-free all common file formats (PDF, ESKO LEN,...) supported with "Flexopower"/bestIMAGE







"Active 3D RIP"



TECHNICAL SPECIFICATIONS

sealed 500W CO, laser Cylinder mounting surface max. 900mm x R1256 Sleeve diameter (outside) 60 - 400 mm (3,4 - 15 inch) Sleeve width 150 - 950 mm (5,9 - 37,4 inch) Resolution variable up to 10.160 dpi Dimensions machine L x W x H 3400 x 1300 x 1315/1860 mm









